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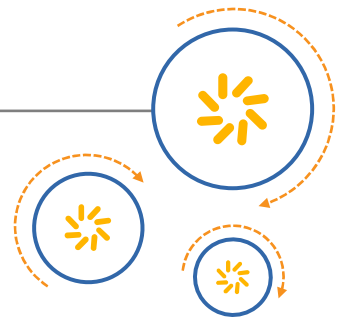
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RF360 Europe GmbH
A Qualcomm – TDK Joint Venture

SAW components

SAW RF filter

Short range devices

Series/type:	B4379
Ordering code:	B39921B4379P810
Date:	April 02, 2018
Version:	2.0

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SAW components	B4379
SAW RF filter	915.0 MHz

Data sheet

Table of contents

1 Application	4
2 Features	4
3 Package	5
4 Pin configuration	5
5 Matching circuit	6
6 Characteristics	7
7 Maximum ratings	8
8 Transmission coefficient	9
9 Packing material	10
10 Marking	13
11 Soldering profile	14
12 ESD protection of SAW filters	15
13 Annotations	16
14 Cautions and warnings	17
Important notes	18

Data sheet

1 Application

- Low-loss RF filter for remote control receivers
- No matching network required for operation at 50 Ω

2 Features

- Package size 1.1±0.1 mm × 0.9±0.1 mm
- Package height 0.45 mm (max.)
- Approximate weight 2 mg
- RoHS compatible
- Package for Surface Mount Technology (SMT)
- Ni/Au-plated terminals
- Filter surface passivated
- Electrostatic Sensitive Device (ESD)
- Moisture Sensitivity Level 2a (MSL2a)
- AEC-Q200 qualified component family (Grade 1: -40 °C to +125 °C)

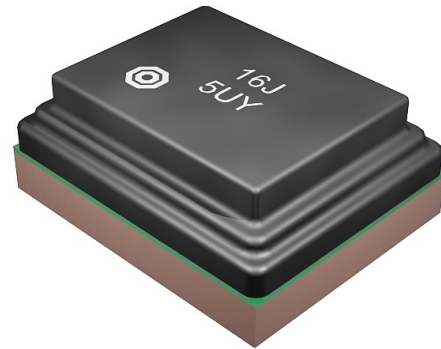


Figure 1: Picture of component with example of product marking.

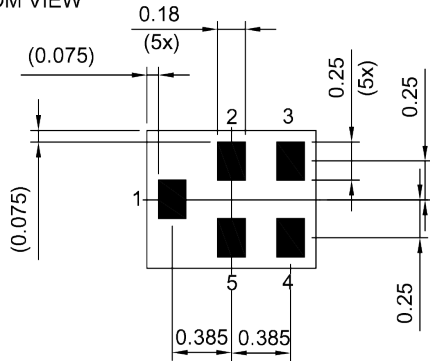
SAW components **B4379**

SAW RF filter **915.0 MHz**

Data sheet

3 Package

BOTTOM VIEW

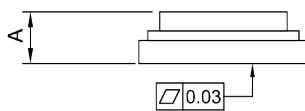


Pad and pitch tolerance ±0.05

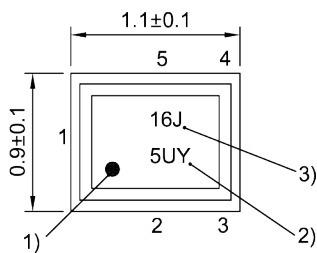
4 Pin configuration

- 1 Input
- 4 Output
- 2, 3, 5 Ground

SIDE VIEW

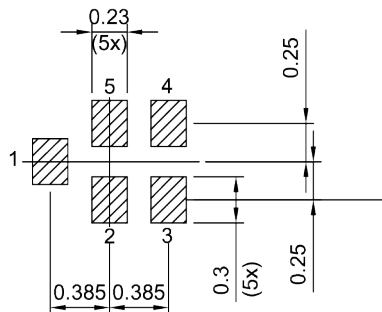


TOP VIEW



- 1) Marking for pad number 1
- 2) Example of encoded lot number
- 3) Example of encoded filter type number

Land pattern THRU VIEW



Landing pad tolerance -0.02

Figure 2: Drawing of package with package height A = 0.45 mm (max.). See Sec. Package information (p. 17).

Data sheet

5 Matching circuit

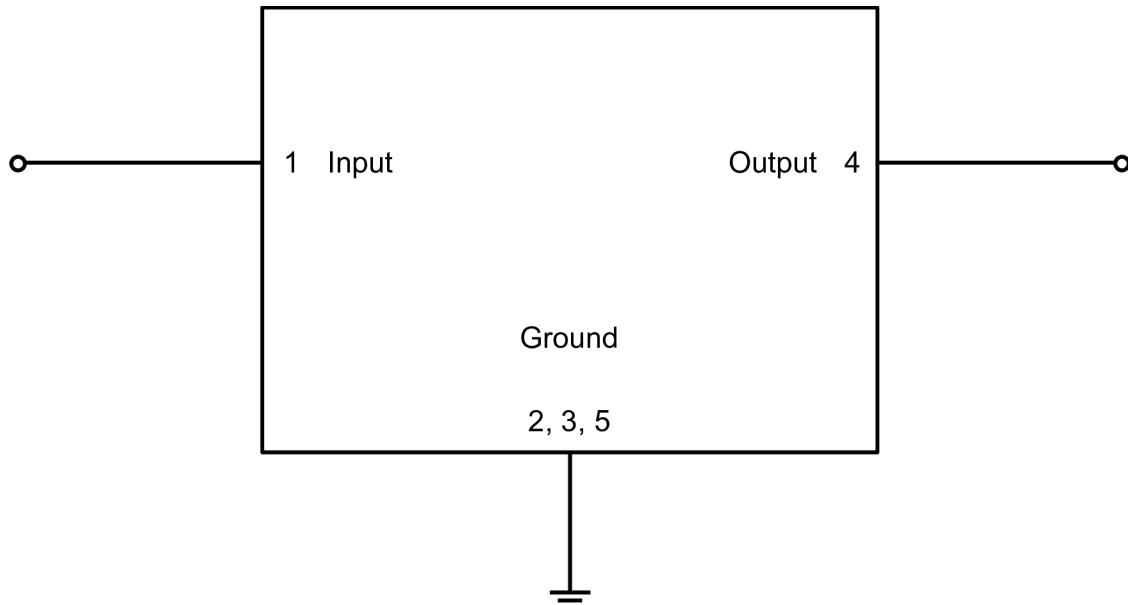


Figure 3: Schematic of matching circuit. No external matching components required.

SAW components

B4379

SAW RF filter

915.0 MHz

Data sheet

6 Characteristics

Temperature range for specification	T_{SPEC}	= -40 °C ... +85 °C
Input terminating impedance	Z_{IN}	= 50 Ω
Output terminating impedance	Z_{OUT}	= 50 Ω

Characteristics			min. for T_{SPEC}	typ. @ +25 °C	max. for T_{SPEC}		
Center frequency		f_C	—	915	—	MHz	
Maximum insertion attenuation	902... 928	MHz	α_{max}	—	1.9	2.3	dB
Amplitude ripple (p-p)	902... 928	MHz	$\Delta\alpha$	—	0.7	1.4	dB
Minimum attenuation	50... 800	MHz	α_{min}	37	40	—	dB
	800... 845	MHz		37	42	—	dB
	845... 880	MHz		37	40	—	dB
	947... 970	MHz		18	34	—	dB
	970... 1020	MHz		33	40	—	dB
	1020... 1200	MHz		33	39	—	dB

SAW components

B4379

SAW RF filter

915.0 MHz

Data sheet

7 Maximum ratings

Operable temperature	$T_{OP} = -40\text{ °C} \dots +125\text{ °C}$	
Storage temperature	$T_{STG}^{1)} = -40\text{ °C} \dots +125\text{ °C}$	
DC voltage	$ V_{DC} ^{2)} = 0\text{ V}$	
Input power @ input port: 902 ... 928 MHz	$P_{IN} = 10\text{ dBm}$	Continuous wave for 100000 h @ 50 °C.

¹⁾ Not valid for packaging material. Storage temperature for packaging material is -25 °C to +40 °C.

²⁾ In case of applied DC voltage blocking capacitors are mandatory.

SAW components	B4379
SAW RF filter	915.0 MHz

Data sheet

8 Transmission coefficient

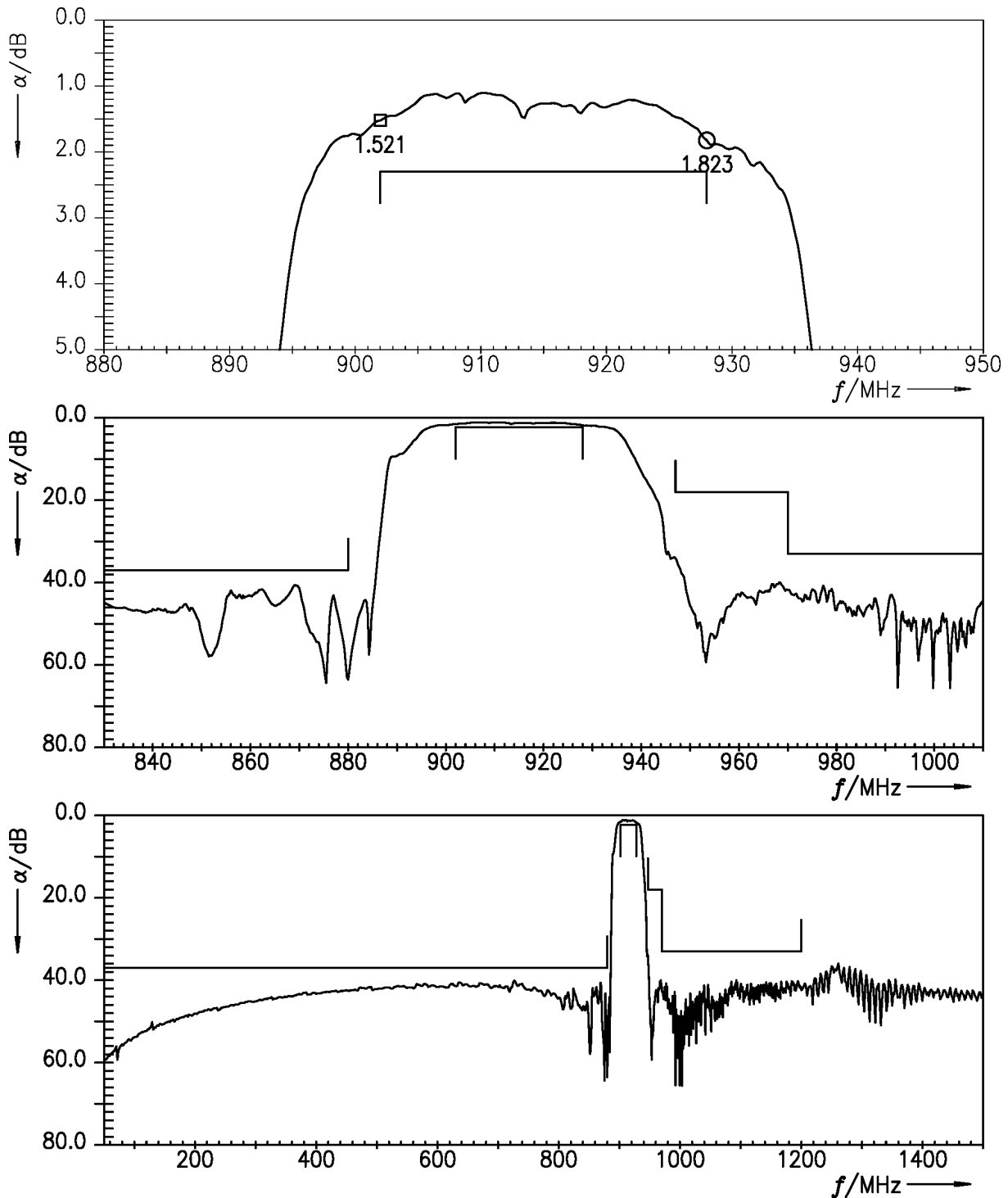


Figure 4: Attenuation.

Data sheet

9 Packing material

9.1 Tape

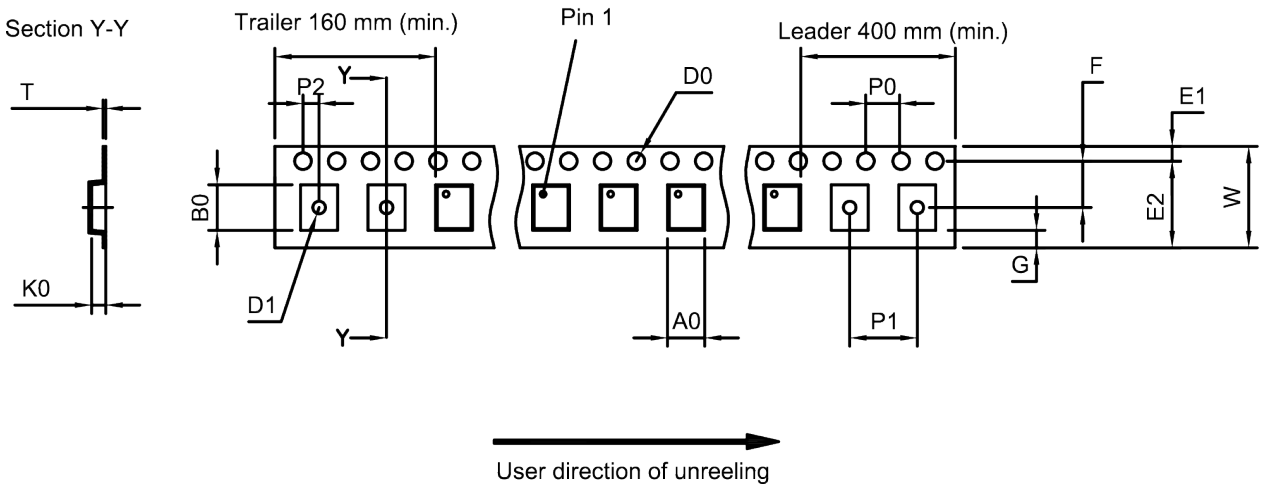


Figure 5: Drawing of tape (first-angle projection) with tape dimensions according to Table 1.

<table border="1" style="width: 100%; border-collapse: collapse;"> <tr><td style="width: 15%;">A₀</td><td>1.02±0.05 mm</td></tr> <tr><td>B₀</td><td>1.22±0.05 mm</td></tr> <tr><td>D₀</td><td>1.55±0.05 mm</td></tr> <tr><td>D₁</td><td>0.55±0.1 mm</td></tr> <tr><td>E₁</td><td>1.75±0.1 mm</td></tr> </table>	A ₀	1.02±0.05 mm	B ₀	1.22±0.05 mm	D ₀	1.55±0.05 mm	D ₁	0.55±0.1 mm	E ₁	1.75±0.1 mm	<table border="1" style="width: 100%; border-collapse: collapse;"> <tr><td style="width: 15%;">E₂</td><td>6.25 mm (min.)</td></tr> <tr><td>F</td><td>3.5±0.05 mm</td></tr> <tr><td>G</td><td>–</td></tr> <tr><td>K₀</td><td>0.6±0.05 mm</td></tr> <tr><td>P₀</td><td>4.0±0.1 mm</td></tr> </table>	E ₂	6.25 mm (min.)	F	3.5±0.05 mm	G	–	K ₀	0.6±0.05 mm	P ₀	4.0±0.1 mm	<table border="1" style="width: 100%; border-collapse: collapse;"> <tr><td style="width: 15%;">P₁</td><td>2.0±0.1 mm</td></tr> <tr><td>P₂</td><td>2.0±0.05 mm</td></tr> <tr><td>T</td><td>0.25±0.03 mm</td></tr> <tr><td>W</td><td>8.0+0.3/-0.1 mm</td></tr> </table>	P ₁	2.0±0.1 mm	P ₂	2.0±0.05 mm	T	0.25±0.03 mm	W	8.0+0.3/-0.1 mm
A ₀	1.02±0.05 mm																													
B ₀	1.22±0.05 mm																													
D ₀	1.55±0.05 mm																													
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T	0.25±0.03 mm																													
W	8.0+0.3/-0.1 mm																													

Table 1: Tape dimensions.

SAW components	B4379
SAW RF filter	915.0 MHz

Data sheet

9.2 Reel with diameter of 180 mm

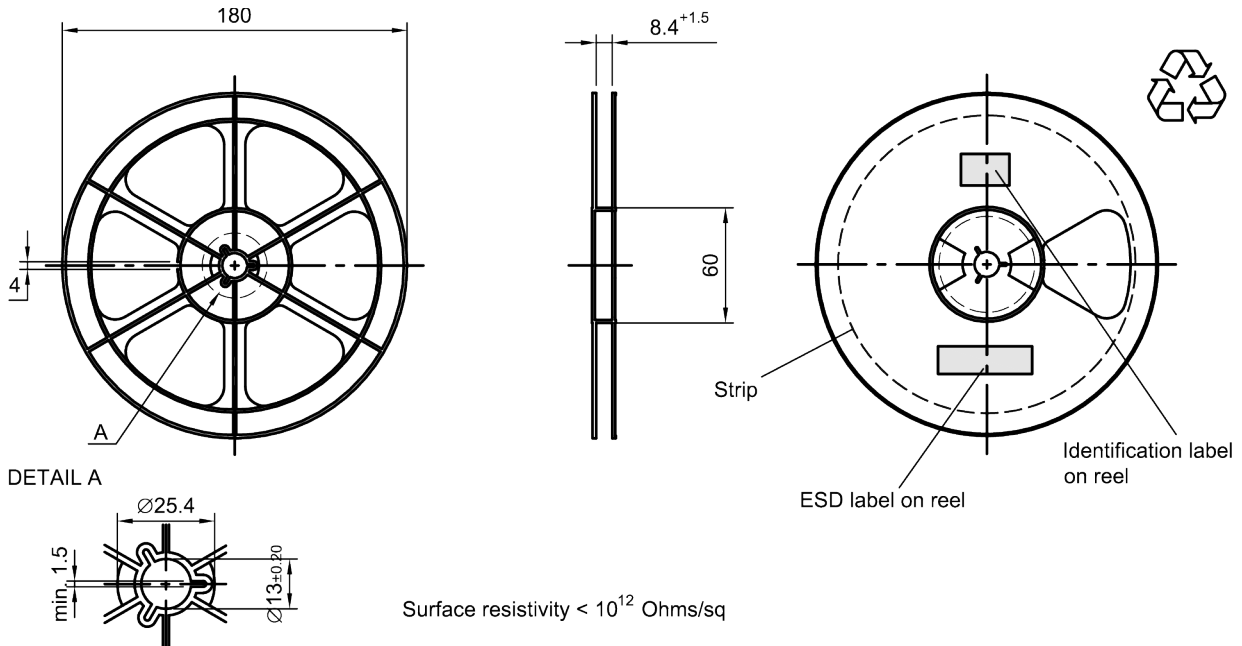


Figure 6: Drawing of reel (first-angle projection) with diameter of 180 mm.

Dimensions [mm]

X = 220+5

Y = 235+5

Sealing area 10±3

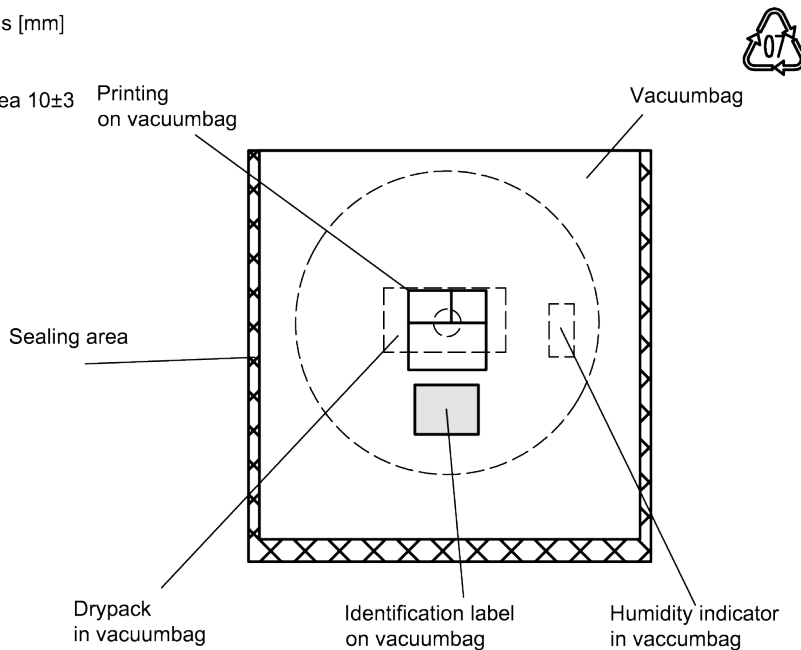


Figure 7: Drawing of moisture barrier bag (MBB) for reel with diameter of 180 mm.

SAW components	B4379
SAW RF filter	915.0 MHz

Data sheet

Dimensions [mm]
 L = 188
 B = 188
 H = 30
 Tolerance ±5

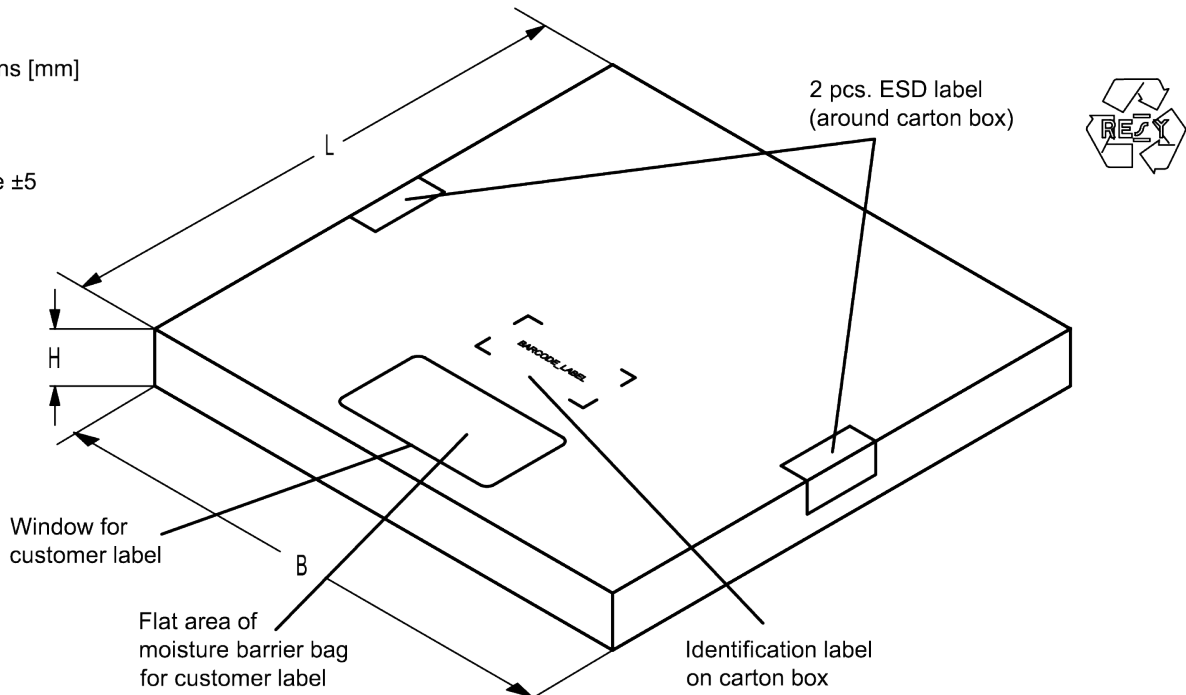


Figure 8: Drawing of folding box for reel with diameter of 180 mm.

SAW components

B4379

SAW RF filter

915.0 MHz

Data sheet

10 Marking

Products are marked with product type number and lot number encoded according to Table 2:

■ Type number:

The 4 digit type number of the ordering code, e.g., B3xxxxB**1234**xxxx,
is encoded by a special BASE32 code into a 3 digit marking.

Example of decoding	type number marking on device	in decimal code.
	16J	1234
	$1 \times 32^2 + 6 \times 32^1 + 18 (=J) \times 32^0$	1234

The BASE32 code for product type B4379 is 48V.

■ Lot number:

The last 5 digits of the lot number, e.g., **12345**,
are encoded based on a special BASE47 code into a 3 digit marking.

Example of decoding lot number marking on device		in decimal code.
5UY	$=>$	12345
$5 \times 47^2 + 27 (=U) \times 47^1 + 31 (=Y) \times 47^0$	=	12345

Adopted BASE32 code for type number			
Decimal value	Base32 code	Decimal value	Base32 code
0	0	16	G
1	1	17	H
2	2	18	J
3	3	19	K
4	4	20	M
5	5	21	N
6	6	22	P
7	7	23	Q
8	8	24	R
9	9	25	S
10	A	26	T
11	B	27	V
12	C	28	W
13	D	29	X
14	E	30	Y
15	F	31	Z

Adopted BASE47 code for lot number			
Decimal value	Base47 code	Decimal value	Base47 code
0	0	24	R
1	1	25	S
2	2	26	T
3	3	27	U
4	4	28	V
5	5	29	W
6	6	30	X
7	7	31	Y
8	8	32	Z
9	9	33	b
10	A	34	d
11	B	35	f
12	C	36	h
13	D	37	n
14	E	38	r
15	F	39	t
16	G	40	v
17	H	41	\
18	J	42	?
19	K	43	{
20	L	44	}
21	M	45	<
22	N	46	>
23	P		

Table 2: Lists for encoding and decoding of marking.

Data sheet

11 Soldering profile

The recommended soldering process is in accordance with IEC 60068-2-58 – 3rd edit and IPC/JEDEC J-STD-020B.

ramp rate	≤ 3 K/s
preheat	125 °C to 220 °C, 150 s to 210 s, 0.4 K/s to 1.0 K/s
$T > 220$ °C	30 s to 70 s
$T > 230$ °C	min. 10 s
$T > 245$ °C	max. 20 s
$T \geq 255$ °C	–
peak temperature T_{peak}	250 °C +0/-5 °C
wetting temperature T_{min}	230 °C +5/-0 °C for 10 s ± 1 s
cooling rate	≤ 3 K/s
soldering temperature T	measured at solder pads

Table 3: Characteristics of recommended soldering profile for lead-free solder (Sn95.5Ag3.8Cu0.7).

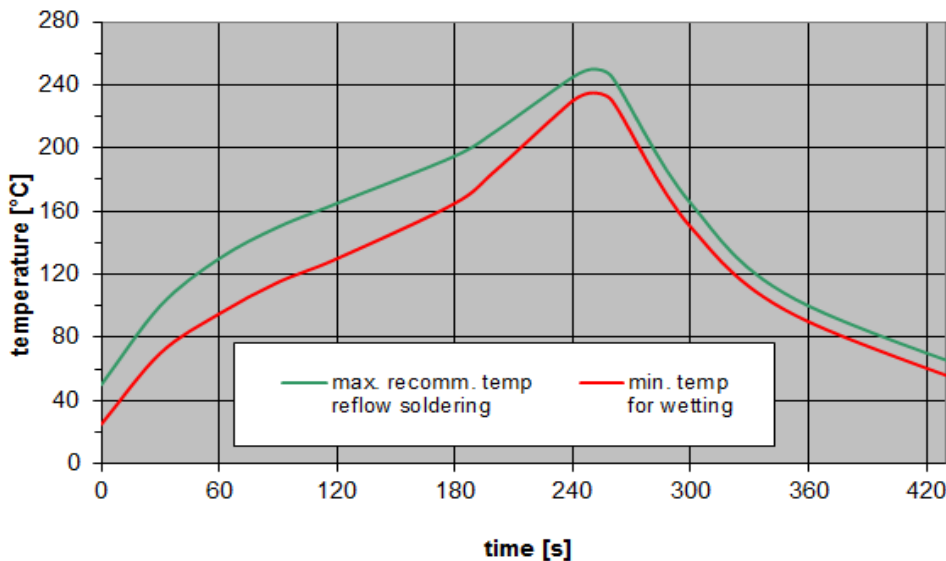


Figure 9: Recommended reflow profile for convection and infrared soldering – lead-free solder.

Data sheet

12 ESD protection of SAW filters

SAW filters are **E**lectro **S**tatic **D**ischarge sensitive devices. To reduce the probability of damages caused by ESD, special matching topologies have to be applied.

In general, “ESD matching” has to be ensured at that filter port, where electrostatic discharge is expected.

Electrostatic discharges predominantly appear at the antenna input of RF receivers. Therefore, only the input matching of the SAW filter has to be designed to short circuit or to block the ESD pulse.

Below three figures show recommended “ESD matching” topologies.

For wide band filters the high-pass ESD matching structure needs to be at least of 3rd order to ensure a proper matching for any impedance value of antenna and SAW filter input. The required component values have to be determined from case to case.

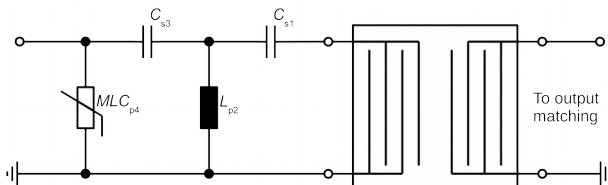


Figure 10: MLC varistor plus ESD matching.

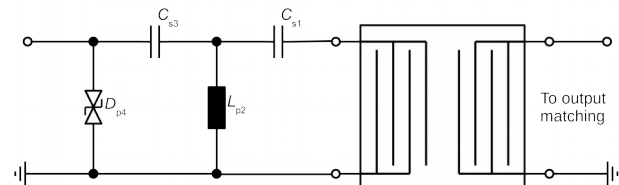


Figure 11: Suppressor diode plus ESD matching.

In cases where minor ESD occur, following simplified “ESD matching” topologies can be used alternatively.

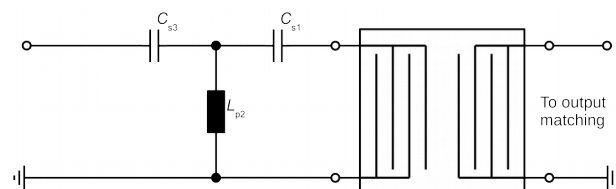


Figure 12: 3rd order high-pass structure for basic ESD protection.

In all three figures the shunt inductor L_{p2} could be replaced by a shorted microstrip with proper length and width. If this configuration is possible depends on the operating frequency and available PCB space.

Effectiveness of the applied ESD protection has to be checked according to relevant industry standards or customer specific requirements.

For further information, please refer to RF360 Application report: “**ESD protection for SAW filters**”. This report can be found under www.rf360jv.com/rke. Click on “Applications Notes”.

SAW components	B4379
SAW RF filter	915.0 MHz

Data sheet

13 Annotations

13.1 Matching coils

See TDK inductor pdf-catalog <http://www.tdk.co.jp/tefe02/coil.htm#aname1> and Data Library for circuit simulation <http://www.tdk.co.jp/etvcl/index.htm>.

13.2 RoHS compatibility

ROHS-compatible means that products are compatible with the requirements according to Art. 4 (substance restrictions) of Directive 2011/65/EU of the European Parliament and of the Council of June 8th, 2011, on the restriction of the use of certain hazardous substances in electrical and electronic equipment ("Directive") with due regard to the application of exemptions as per Annex III of the Directive in certain cases.

13.3 Scattering parameters (S-parameters)

The pin/port assignment is available in the headers of the S-parameter files. Please contact your local RF360 sales office.

Data sheet

14 Cautions and warnings

14.1 Display of ordering codes for RF360 products

The ordering code for one and the same product can be represented differently in data sheets, data books, other publications and the website of RF360, or in order-related documents such as shipping notes, order confirmations and product labels. The varying representations of the ordering codes are due to different processes employed and do not affect the specifications of the respective products. Detailed information can be found on the Internet under www.rf360jv.com/orderingcodes.

14.2 Material information

Due to technical requirements components may contain dangerous substances. For information on the type in question please also contact one of our sales offices.

For information on recycling of tapes and reels please contact one of our sales offices.

14.3 Moldability

Before using in overmolding environment, please contact your local RF360 sales office.

14.4 Package information

Landing area

The printed circuit board (PCB) land pattern (landing area) shown is based on RF360 internal development and empirical data and illustrated for example purposes, only. As customers' SMD assembly processes may have a plenty of variants and influence factors which are not under control or knowledge of RF360, additional careful process development on customer side is necessary and strongly recommended in order to achieve best soldering results tailored to the particular customer needs.

Dimensions

Unless otherwise specified all dimensions are understood using unit millimeter (mm).

Dimensions do not include burrs.

Projection method

Unless otherwise specified first-angle projection is applied.

Important notes

The following applies to all products named in this publication:

1. Some parts of this publication contain **statements about the suitability of our products for certain areas of application**. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out **that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application**. As a rule, RF360 Europe GmbH and its affiliates are either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether an RF360 product with the properties described in the product specification is suitable for use in a particular customer application.
2. We also point out that **in individual cases, a malfunction of electronic components or failure before the end of their usual service life cannot be completely ruled out in the current state of the art, even if they are operated as specified**. In customer applications requiring a very high level of operational safety and especially in customer applications in which the malfunction or failure of an electronic component could endanger human life or health (e.g. in accident prevention or life-saving systems), it must therefore be ensured by means of suitable design of the customer application or other action taken by the customer (e.g. installation of protective circuitry or redundancy) that no injury or damage is sustained by third parties in the event of malfunction or failure of an electronic component.
3. **The warnings, cautions and product-specific notes must be observed.**
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